

CLC002 SMPTE 292M / 259M Serial Digital Cable Driver

Check for Samples: [CLC002](#)

FEATURES

- **SMPTE 292M, SMPTE 344M and SMPTE 259M Compliant**
- **Data Rates to 1.485 Gbps**
- **Differential Input**
- **75Ω Differential Output**
- **Selectable Slew Rate**
- **Adjustable Output Amplitude**
- **Single 3.3V Supply Operation**
- **Operating Temperature Range: Commercial 0°C to +70°C (CLC002MA) or Industrial –40°C to +85°C (CLC002TMA)**
- **Typical Power Consumption: 125mW in SD Mode and 149mW in HD Mode**
- **Replaces the GS1528 and GS1528A**

DESCRIPTION

The CLC002 SMPTE 292M / 259M serial digital cable driver is a monolithic, high-speed cable driver designed for use in SMPTE 292M / 259M serial digital video and ITU-T G.703 serial digital data transmission applications. The CLC002 drives 75Ω transmission lines (Belden 8281, Belden 1694A or equivalent) at data rates up to 1.485 Gbps.

The CLC002 provides two selectable slew rates for SMPTE 259M and SMPTE 292M compliance. The output voltage swing is adjustable via a single external resistor.

The CLC002 is powered from a single 3.3V supply. Power consumption is typically 125mW in SD mode and 149mW in HD mode.

APPLICATIONS

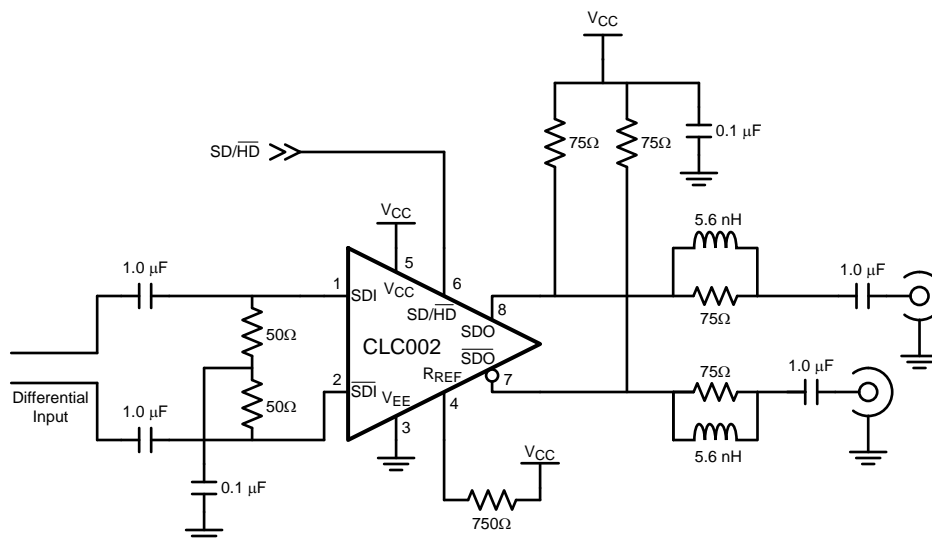
- **SMPTE 292M, SMPTE 344M, and SMPTE 259M Serial Digital Interfaces**
- **Sonet/SDH and ATM Interfaces**
- **Digital Routers and Switches**
- **Distribution Amplifiers**
- **Buffer Applications**
- **Set Top Boxes**
- **Security Cameras**



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TYPICAL APPLICATION



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Supply Voltage:		–0.5V to 3.6V
Input Voltage (all inputs)		–0.3V to $V_{CC}+0.3V$
Output Current		28mA
Storage Temperature Range		–65°C to +150°C
Junction Temperature		+150°C
Lead Temperature (Soldering 4 Sec)		+260°C
Package Thermal Resistance	θ_{JA} 8-pin SOIC	+125°C/W
	θ_{JC} 8-pin SOIC	+105°C/W
ESD Rating (HBM)		5kV
ESD Rating (MM)		250V

- (1) "Absolute Maximum Ratings" are those parameter values beyond which the life and operation of the device cannot be ensured. The stating herein of these maximums shall not be construed to imply that the device can or should be operated at or beyond these values. The table of "Electrical Characteristics" specifies acceptable device operating conditions.

RECOMMENDED OPERATING CONDITIONS

Supply Voltage ($V_{CC} - V_{EE}$):		3.3V ±5%
Operating Free Air Temperature (T_A)	CLC002MA	0°C to +70°C
	CLC002TMA	–40°C to +85°C

DC ELECTRICAL CHARACTERISTICS

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified ⁽¹⁾⁽²⁾.

Symbol	Parameter	Conditions	Reference	Min	Typ	Max	Units
V_{CMIN}	Input Common Mode Voltage		SDI, \overline{SDI}	1.6 + $V_{SDI}/2$		$V_{CC} - V_{SDI}/2$	V
V_{SDI}	Input Voltage Swing	Differential		100		2000	mV _{P-P}

- (1) Current flow into device pins is defined as positive. Current flow out of device pins is defined as negative. All voltages are stated referenced to $V_{EE} = 0$ Volts.

- (2) Typical values are stated for $V_{CC} = +3.3V$ and $T_A = +25^\circ C$.

DC ELECTRICAL CHARACTERISTICS (continued)

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified ⁽¹⁾⁽²⁾.

Symbol	Parameter	Conditions	Reference	Min	Typ	Max	Units
V _{CMOUT}	Output Common Mode Voltage		SDO, $\overline{\text{SDO}}$		$V_{CC} - V_{SDO}$		V
V _{SDO}	Output Voltage Swing	Single-ended, 75Ω load, R _{REF} = 750Ω 1%		750	800	850	mV _{P-P}
		Single-ended, 75Ω load, R _{REF} = 590Ω 1%		900	1000	1100	mV _{P-P}
	SD/ $\overline{\text{HD}}$ Input Voltage	Min for SD	SD/ $\overline{\text{HD}}$	2.4			V
		Max for HD				0.8	V
	SD/ $\overline{\text{HD}}$ Input Current				3.7		μA
I _{CC}	Supply Current	SD/ $\overline{\text{HD}}$ = 0, ⁽³⁾			45	49	mA
		SD/ $\overline{\text{HD}}$ = 1, ⁽³⁾			38	43	mA

(3) Maximum I_{CC} is measured at V_{CC} = +3.465V and T_A = +70°C.

AC ELECTRICAL CHARACTERISTICS

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified ⁽¹⁾.

Symbol	Parameter	Conditions	Reference	Min	Typ	Max	Units
DR _{SDI}	Input Data Rate	See ⁽²⁾	SDI, $\overline{\text{SDI}}$			1485	Mbps
t _{jitter}	Additive Jitter	1.485 Gbps	SDO, $\overline{\text{SDO}}$		26		pS _{P-P}
		270 Mbps			18		pS _{P-P}
t _r , t _f	Output Rise Time, Fall Time	SD/ $\overline{\text{HD}}$ = 0, 20% – 80%, ⁽³⁾			120	220	ps
		SD/ $\overline{\text{HD}}$ = 1, 20% – 80%		400	560	800	ps
	Mismatch in Rise/Fall Time	See ⁽²⁾				30	ps
t _{OS}	Output Overshoot	See ⁽²⁾				8	%
RL _{SDO}	Output Return Loss	⁽⁴⁾		15	20		dB

(1) Typical values are stated for V_{CC} = +3.3V and T_A = +25°C.

(2) Specification is ensured by characterization.

(3) Specification is ensure by characterization and verified by test.

(4) Output return loss is dependent on board design. The CLC002 meets this specification on the SD002 evaluation board from 5MHz to 1.5GHz.

CONNECTION DIAGRAM

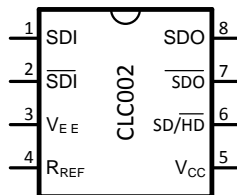


Figure 1. 8-Pin SOIC

PIN DESCRIPTIONS

Pin #	Name	Description
1	SDI	Serial data true input.
2	$\overline{\text{SDI}}$	Serial data complement input.
3	V _{EE}	Negative power supply (ground).
4	R _{REF}	Output driver level control. Connect a resistor to V _{CC} to set output voltage swing.
5	V _{CC}	Positive power supply (+3.3V).

PIN DESCRIPTIONS (continued)

Pin #	Name	Description
6	SD/HD	Output slew rate control. Output rise/fall time complies with SMPTE 292M when low and SMPTE 259M when high.
7	$\overline{\text{SDO}}$	Serial data complement output.
8	SDO	Serial data true output.

DEVICE OPERATION**INPUT INTERFACING**

The CLC002 accepts either differential or single-ended input. The inputs are self-biased, allowing for simple AC or DC coupling. DC-coupled inputs must be kept within the specified common-mode range. SDI and $\overline{\text{SDI}}$ are self-biased at approximately 2.1V with $V_{CC} = 3.3\text{V}$. Figure 2 shows the differential input stage for SDI and $\overline{\text{SDI}}$.

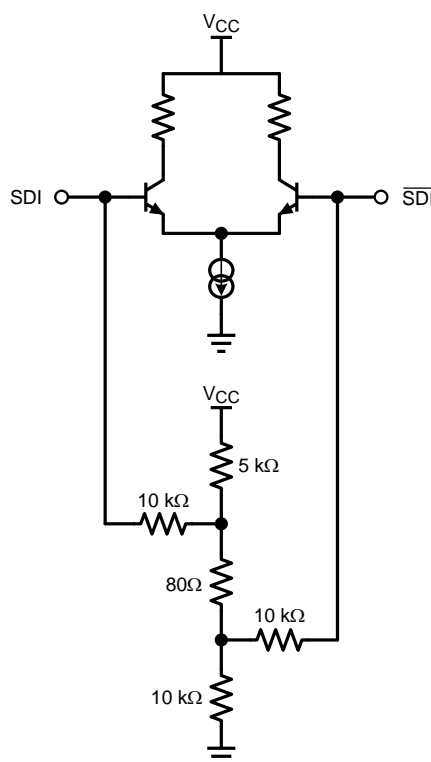


Figure 2. Differential Input Stage for SDI and $\overline{\text{SDI}}$.

OUTPUT INTERFACING

The CLC002 uses current mode outputs. Single-ended output levels are 800 mV_{P-P} into 75Ω AC-coupled coaxial cable (with $R_{REF} = 750\Omega$). Output level is controlled by the value of the R_{REF} resistor connected between pin 4 and V_{CC} .

The R_{REF} resistor should be placed as close as possible to the R_{REF} pin. In addition, the copper in the plane layers below the R_{REF} network should be removed to minimize parasitic capacitance.

OUTPUT SLEW RATE CONTROL

The CLC002 output rise and fall times are selectable for either SMPTE 259M or SMPTE 292M compliance via pin 6, SD/HD. For slower rise and fall times, or SMPTE 259M compliance, SD/HD is set high. For faster rise and fall times, or SMPTE 292M compliance, SD/HD is set low.

REPLACING THE GENNUM GS1528

The CLC002 is form-fit-function compatible with the Gennum GS1528 and GS1528A.

REVISION HISTORY

Changes from Revision F (April 2013) to Revision G

Page

- Changed layout of National Data Sheet to TI format [5](#)

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